APPLICA	BLE STANDA	RD									
	OPERATING TEMPERATURE RANGE VOLTAGE CURRENT					DRAGE MPERATURE RANGE		-	-10 °C TO +60 °C(1)		
RATING			60 V AC/DC	STORAGE HUMIDITY RANGE		ANGE	REL	5% M	AX		
			2 A			WIDITTHANGE			(NOT DEWED)		
			SPECIF	FICAT	IONS						
	ITEM		TEST METHOD				REQ	UIREM	IENTS	QT	Α
CONSTRI								<u> </u>			
	EXAMINATION	VISUALL	Y AND BY MEASURING IN	STRUME	NT.	ACCOF	RDING TO D	RAWING	i.	×	>
MARKING		CONFIRMED VISUALLY.								×	>
ELECTRI	C CHARACTER	RISTICS									
CONTACT RESISTANCE		1A DC.				10 mΩ MAX.				×	-
CONTACT RESISTANCE MILLIVOLT LEVEL METHOD		10 mV AC MAX, 0.1 mA(DC OR 1000Hz)			1	10 mΩ MAX.				×	-
INSULATION RESISTANCE		500 V DC.			1	100 MΩ MIN.				×	-
VOLTAGE PROOF		1000 V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.				×	-
MECHANICAL CHARAC						THE PERCHASIAN OF BRIDARDOVING					
	AL OPERATION		S INSERTIONS AND EXTRA	CTIONS		① COI	NTACT RES	ISTANCE	: 20 mΩ MAX.	×	Ι-
						② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	-
VIBRATION		FREQUENCY 20 TO 200Hz (88m/s ²)				 NO ELECTRICAL DISCONTINUITY OF 7ΩMIN , 1μs MIN. CONTACT RESISTANCE: 20 mΩ MAX. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 				×	-
		SWEEP TIME 3min.(ROUND TRIP) AT 3h FOR 3 DIRECTIONS.								×	-
		AT SITT ON S DIRECTIONS.									
SHOCK		981m/s ² DURATION OF PULSE 6ms AT 3 TIMES FOR 6 DIRECTIONS.			MES (① NO ELECTRICAL DISCONTINUITY OF $7\Omega \text{MIN}$,				×	-
						1μs MIN.					
					G	② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	-
LOCK STRE	NGTH	MEASURE BREAK STRENGTH OF THE LOCK BY			K BY	① 100N MIN.				×	-
		PULLING DIRECTI	I THE CONNECTOR IN THE ON.	MATING	G						
ENVIRON	IMENTAL CHA	RACTER	RISTICS		I						
DAMP HEAT	=	EXPOSED AT 60 °C, 90 ~ 95 %, 96 h.						_	: 20 mΩ MAX.	×	-
(STEADY S	TATE)					 ② INSULATION RESISTANCE:100 MΩ MIN. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 				×	-
RAPID CHANGE OF		TEMPERATURE- 40 →ROOM TEMP →125°C→				① CONTACT RESISTANCE: 20 mΩ MAX.				×	-
TEMPERATURE		ROOM TEMP TIME $30 \rightarrow 5 \rightarrow 30 \rightarrow 5 \text{ min}$ UNDER 1000 CYCLES.				② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	-
DRY HEAT			D AT 140°C, 120 h.			① CON	NTACT RES	ISTANCE	: 20 mΩ MAX.	×	-
						② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	-
COLD		EVENOPED AT 1000 1001				① CONTACT RESISTANCE: 20 m Ω MAX.				×	-
COLD		EXPOSED AT -40°C , 120 h.			C	② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	-
RESISTANCE TO SO ₂ GAS		EXPOSE	EXPOSED IN 25 PPM AT 75% MIN FOR 96h.			① CONTACT RESISTANCE: 20 mΩ MAX.				×	-
RESISTANCE TO		REFLOW TEMP. OVER 260°C, 10sec.				NO PLATING PEELING OF THE TERMINALS,					-
SOLDERING		PREHEAT 180°CMAX, 120sec.				MELTINGS OF HOUSINGS.					
SOLDERAB	ILITY	SOLDER PROFILE	ED AT SPECIFIED TEMPER :.	RATURE	5	SHALL	COVER A N	MUMININ	OF SOLDER OF 95 % OF	×	-
0011	IT Sec	 	LOE DEVIOLONO				JRFACE BE			F.	<u></u>
COUN	VI DES		OF REVISIONS		DESIGN				CHECKED		TE
1 DIS-T- REMARK (NOTE1) "STORAGE" means a long-term storbefore assembly to PCB. Note QT:Qualification Test AT:Assurar						APPROVED CHECKED DESIGNED			HH. TSUKUMO HK. UMEHARA HK. UMEHARA TY. ISHIGURO		090
											101 101
											101
							DRAWN		MN. SATOH	2017	
						RAWING NO.			l.		
NOTE Q1:Q		ECIFICATION SHEET			PART NO.			ELC-376618-00			,
HS										3 \	4 /
FORM HD0011-2-1			LECTRIC CO., LTD.			NO.	CL07	CL0752-2312-0-00			1/